Spontaneous growth of bismuth nanowires on a sputter-deposited thin bismuth film

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ABSTRACT

Thin films of bismuth of thickness 100 nm have been deposited onto Si(111) substrates held at 120 °C using magnetron sputter deposition. The three-inch magnetrons were operated at DC powers between 30 W and 50 W to give deposition rates between 0.03 and 0.09 nms^{-1}. Examination of the surface of the thin films using scanning electron microscopy revealed nanowires of diameter 80–120 nm and length between 3 and 16 μm emerging from the film. An investigation of the effect of deposition rate found little influence on the nanowire diameter, but indicated that some longer nanowires could be found on the film deposited at the lowest rate. A 20 nm film grown on glass at 110 °C shows a nanowire with dimension of around 50 nm. Using a relatively higher rate for the first 25 nm followed by a lower rate to 100 nm produced some very straight and regular nanorods.

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1. Introduction

Bismuth is a group V semi-metal that has been the focus of research spanning decades, motivated by several interesting properties that it possesses. Firstly, the carrier density of bismuth is much lower than the other metals, 10^5 times smaller at liquid helium temperatures than in conventional metals, resulting in a relatively high resistivity [1]. Secondly, conduction electrons in bismuth have a very small effective mass. Thirdly they have a long carrier mean free path (~100 nm at 300 K and ~400 μm at 4 K) [2] and finally the wavelength of electrons at the Fermi level is very long giving rise to more prominent quantum confinement effects in bismuth nanowires than in other materials. Bismuth has a small band overlap energy between its L-point conduction band and T-point valence band (38 meV at 77 K) [3], anisotropic Fermi surface [4], low density of states [5] and high carrier mobility [6]. It is reported that the small overlap between the valence and conduction bands means that it may be converted from a semimetal to a semiconductor by reducing the dimensions of the material [7].

The crystal structure of bismuth is rhombohedral [8], but it is often described by reference to a hexagonal unit cell (or very occasionally by reference to a pseudocubic cell); here we will indicate planes and directions notated in the rhombohedral scheme by subscript R and in the hexagonal scheme by subscript H. Bismuth has equal densities of holes and electrons, which cancels contributions to the Seebeck coefficient leading to bulk bismuth being a poor thermoelectric material [9]. Bismuth nanowires, however, are expected to have a good thermoelectric efficiency [4] due to the reduced dimensionality [10–12].

Given the long Fermi wavelength of bismuth, quantum confinement is expected in nanowires of quite large dimension [13,14]. There is a rapidly increasing interest in the production of bismuth nanowires as evidenced by the large number of publications in this field over the past few years. However, bismuth nanowires have been found to be difficult to fabricate as bismuth has a very low meting point (271 °C). Two broad groups of methods for their fabrication are template methods and on-film formation, each with its own inherent challenges and each producing nanowires with different crystallinities, regularity and diameter control.

Template methods may use either pressure injection [15] or electrochemical techniques to introduce bismuth into a porous alumina template or glass capillary. This method has good diameter control and the challenge is to produce nanowires with good regularity and crystallinity; developments over time have refined these methods. Pressure injection can result in single crystal nanowires grown along the length of the alumina template, but requires dissolving the template and manipulation of the solution in order to obtain single, separated nanowires [16]. Similar methods using electro-deposition have also been very successful [17,18,5] and good-quality nanowires have been manufactured by a template-free process [19].

Alternative methods for bismuth nanowire formation use physical vapour deposition (PVD). The attraction of PVD is that it can more readily produce structures that have high degrees of perfection in terms of crystallinity and regularity of the surface. One such PVD based method for nanowire production involves on film growth. In this method, nanowires are extruded from a bismuth film by post-deposition stress. One way to achieve this that has been reported involves the deposition of a bismuth–chromium-nitride composite film, which extrudes bismuth nanowires due to stress retained within the film [20]. Another method involves the on–off process where a

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bismuth thin film is deposited onto a thermally oxidised silicon substrate [21]. After deposition the substrate is made to flex by cycling between high temperature and room temperature and the induced stress extrudes bismuth nanowires.

Recently there have been several reports of the spontaneous growth of bismuth nanowires and whiskers from sputter-deposited thin films without the requirement for post-deposition heating [22–26]. This PVD method requires the deposition of bismuth using magnetron sputtering at a low-rate onto a substrate that is maintained at an elevated temperature. If, for example, a 500 nm film is deposited then upon examination using scanning electron microscopy numerous whiskers or nanowires of length of several micro-metres are found to have grown from the films at a non-normal angle. The obvious attractions of this method of growing bismuth nanowires are that because the structures are produced by a natural crystallisation process they have a high degree of crystallinity, have smooth surfaces and can be manufactured relatively simply. The smoothness and crystallinity of these nanowires should make them suitable for investigations of fundamental physical properties.

Examination of certain PVD grown nanowires using transmission electron microscopy shows that they are crystalline with a $[110]_H$ growth direction [22,25] but other reports suggest that $[012]_H$ growth is also possible [26]. With low growth rates they emerge at angles around 54° off-normal and appear to be promoted by the existence of $[110]_R$, $[012]_H$ orientational texture in the film [23]. It has been suggested [25] that the growth direction precludes growth from the more dominant $[001]_H$, $[111]_R$ texture that is particularly produced by evaporation deposition as the growth direction $[110]_H$ would then be within plane. For films grown on glass substrates it has also been pointed out that the thermal expansion coefficient of bismuth greatly exceeds that of glass so that cooling the sample from growth temperature to room temperature will not stress the film, making a stress-driven growth mechanism less likely [25]. The intriguing possibility that the whiskers grow in situ during film growth would be consistent with the observation that they grow on several different substrates [23].

Given the high degree of regularity apparent the method could be utilised to manufacture high-quality nanowires provided that the control of diameter could be achieved. The growth mechanism of these whiskers is not known, but it has been proposed that they could grow around a spiral dislocation [22], or be the result of a catalyst free diffusion driven mechanism [23] such as asymmetric corner-crossing [26]. It has been reported that the film growth time [25] or growth rate [24] affects the diameter of the whiskers. The argument supporting the growth rate influence is that it has been shown that asymmetric corner-crossing produces bismuth nano-structures with an aspect ratio that is rate dependent [27]. These arguments suggest the intriguing possibility that by varying deposition conditions it may be possible to control the diameter of the nanowire produced. Nanowires emerging from a film deposited using RF sputtering at low rates have shown a variation in diameter with deposition rate [24]. In this work varying sputter power was used to grow films at rates between 0.044 and 0.341 nms^{-1} and deposition was for a period of 40 min. The nanowires emerging from these films had diameters between 20 and 400 nm respectively. Alternatively, in another report using slightly higher growth rate, a linear relationship was found between growth time and nanowire diameter in the range 100–600 nm at constant rate (though with a non-zero intercept) [25].

We have recently reported the growth of 500 nm diameter whiskers on 500 nm bismuth thin films [23] and indicated that nanowires may also be produced given a suitably thin film. Here we report on this phenomenon further, this time focussing on the production of nanowire diameter of order 100 nm or less. Given the importance of diameter control for the utility of this technique we have investigated the production of nanowires in the diameter range around 100 nm (and smaller) and the influence of growth parameters. We present an illustration of the utility of the use of the slow growth sputter-method for producing bismuth nanowires and nanorods.

2. Experimental

The bismuth nanowires grow naturally from crystallites in a bismuth thin film during deposition when the substrate temperature is suitably elevated. To enable formation of nanowires, it is important to grow the underlying films slowly. This was undertaken in a clean high vacuum physical vapour deposition system.

The bismuth thin films were deposited onto (111) oriented squares of silicon wafer of dimensions 20 mm by 20 mm (with the native oxide intact) or in one case onto glass. Prior to loading, the substrates were cleaned by degreasing and drying using acetone. The deposition was carried out using either pulsed DC or radio frequency (RF) planar magnetron sputtering in a thin films system manufactured by PVD Products Inc., Wilmington MA, USA. The vacuum chamber is made from stainless steel and is pumped by a rotary pump, turbo-molecular pump combination. It can be subjected to a light "bake-out" using internal quartz heaters. The base pressure during the experiments was 2×10^{-8} Torr which could be maintained by using a load-lock.

The bismuth target was supplied by Testbourne Ltd. and was of 99.99% purity. It was mounted into a 3″ PVD Products Titan planar magnetron in the sputter-up configuration. In this system the axis of the magnetron is inclined at an angle of 35° to the vertical and the target-substrate distance is 15 cm. The power for the magnetron could be externally changed between DC and RF power. The DC power supplied by an Advanced Energy MDX 1 K supply was used, combined with a Sparc-LE 20 unit in auto-run mode at 20 kHz to supress arc formation [28]. Alternatively, RF power was supplied by a Dressler Cesar RF power generator. To ensure film uniformity the substrate was rotated at a rate of thirty times per minute. Before admitting the 99.9999% argon process gas the turbo-molecular pump was throttled and gas flow (and so sputtering pressure) was controlled by an MKS mass-flow controller.

To enable nanowire growth, the substrate temperature was held at 120 °C, except where otherwise stated. Heating was accomplished using a bank of quartz heaters behind the substrate and the temperature was measured using a thermocouple and controlled using a Eurotherm 2408 proportional–integral–derivative controller. The films deposited were 100 nm thick, except where otherwise stated, the deposition rate being measured by an Inficon XTC quartz crystal monitor. The rate monitor had previously been calibrated against measurements of film thickness using both X-ray reflectivity and scanning electron microscope of a fractured substrate imaged edge-on. Following deposition, films were examined using scanning electron microscopy (SEM), employing a Leo 1530FE high resolution field emission gun scanning electron microscope.

3. Results and discussion

The reports of the influence of growth rate [24] or that diameter is proportional to deposition time beyond a minimum of 171 nm when the film is grown at a rate between 1 and 4 nms^{-1} [25] and that whiskers emerging from a 100 nm film have diameter of around 80 nm [23] pose the question: can film growth rate, growth time or film thickness be manipulated to give nanowires that are controllably in the range of 100 nm diameter or smaller? This latter, rather arbitrary figure was selected as it approximates to the Fermi wavelength in bismuth. To this end we have deposited and examined a series of 100 nm thick bismuth films deposited at different rates by varying the magnetron power with all other parameters held constant. In each case the films were grown to a specific thickness rather than for a specific time.

Fig. 1 shows electron micrographs collected from bismuth films grown at different deposition rates. These were deposited onto sections of Si(111) wafer using DC magnetron sputtering. During deposition the substrate was held at 120 °C and all the films are of 100 nm thickness. An important point that needs to be made is that compared with 500 nm films previously reported [23] the deposition of thinner films,